



**SDI Review Form 1.6**

Journal Name:	<a href="#">Journal of Engineering Research and Reports</a>
Manuscript Number:	Ms_JERR_59175
Title of the Manuscript:	Implementing Single-row Process Plate Design for Pre-encapsulated Leadframe
Type of the Article	Original Research Article

**General guideline for Peer Review process:**

This journal's peer review policy states that **NO** manuscript should be rejected only on the basis of '**lack of Novelty**', provided the manuscript is scientifically robust and technically sound. To know the complete guideline for Peer Review process, reviewers are requested to visit this link:

(<http://www.sciencedomain.org/journal/10/editorial-policy> )

**PART 1: Review Comments**

	Reviewer's comment	Author's comment (if agreed with reviewer, correct the manuscript and highlight that part in the manuscript. It is mandatory that authors should write his/her feedback here)
<b>Compulsory</b> REVISION comments	No.	
<b>Minor</b> REVISION comments	1.The current states and progress of conventional method of wirebonding of "panel type" need to reviewed in the "Introduction" and more references need to be cited as well. 2. For the Fig. 6 and Fig. 7, Y axis and the value should be marked to have the reader know the warpage of "panel type" and single row, before and after wirebonding.	
<b>Optional/General</b> comments	NO.	

**PART 2:**

	Reviewer's comment	Author's comment (if agreed with reviewer, correct the manuscript and highlight that part in the manuscript. It is mandatory that authors should write his/her feedback here)
Are there ethical issues in this manuscript?	(If yes, Kindly please write down the ethical issues here in details)	

**Reviewer Details:**

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